imall

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Transistors with Built-in Resistor DRC3144T0L

DRC3144T0L Silicon NPN epitaxial planar type

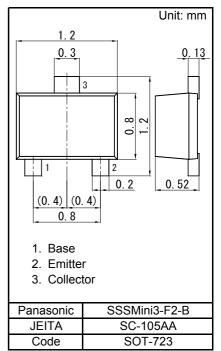
For digital circuits Complementary to DRA3144T DRC9144T in SSSMini3 type package

Features

- · High forward current transfer ratio hFE with excellent linearity
- · Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant
 (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: NP

Packaging

Embossed type (Thermo-compression sealing) : 10 000 pcs / reel (standard)



Internal Connection						
B O-C						
·oe						
Resistance value	R1	47	kΩ			

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	VCBO	50	V	
Collector-emitter voltage (Base open)	VCEO	50	V	
Collector current	IC	100	mA	
Total power dissipation	PT	100	mW	
Junction temperature	Tj	150	°C	
Operating ambient temperature	Topr	-40 to +85	°C	
Storage temperature	Tstg	-55 to +150	С°	

Electrical Characteristics	Ta = 25 °C ± 3 °C
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Parameter	Symbol	Conditions	Min	Тур	Max	Unit		
Collector-base voltage (Emitter open)	VCBO	IC = 10 μA, IE = 0	50			V		
Collector-emitter voltage (Base open)	VCEO	IC = 2 mA, IB = 0	50			V		
Collector-base cutoff current (Emitter open)	ICBO	VCB = 50 V, IE = 0			0.1	μA		
Collector-emitter cutoff current (Base open)	ICEO	VCE = 50 V, IB = 0			0.5	μA		
Emitter-base cutoff current (Collector open)	IEBO	VEB = 6 V, IC = 0			0.01	mA		
Forward current transfer ratio	hFE	VCE = 10 V, IC = 5 mA	160		460	-		
Collector-emitter saturation voltage	VCE(sat)	IC = 10 mA, IB = 0.5 mA			0.25	V		
Input voltage	Vi(on)	VCE = 0.2 V, IC = 5 mA	2.8			V		
	Vi(off)	VCE = 5 V, IC = 100 µA			0.4	V		
Between emitter base resistance	R1		-30%	47	+30%	kΩ		

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

Transistors with Built-in Resistor **DRC3144T0L**

IB = 350 μA

.300 µA

250 µA

200 µA

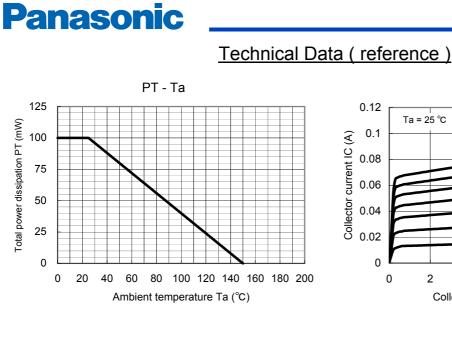
150 µA

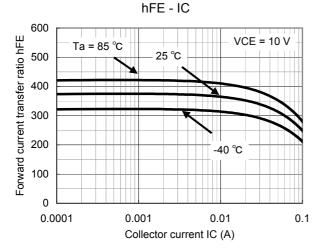
100 µA

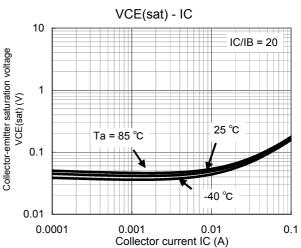
50 µA

12

10







IC - VCE

Ta = 25 °C

2

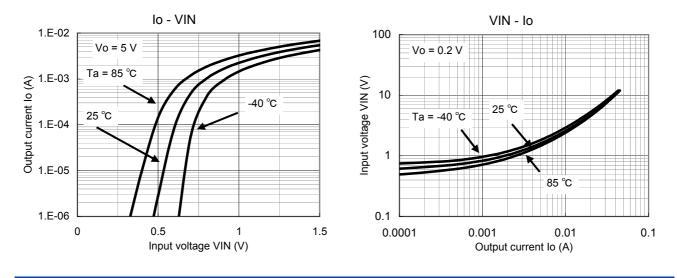
4

6

Collector-emitter voltage VCE (V)

8

0



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Established : 2009-10-27 Revised : 2014-03-20



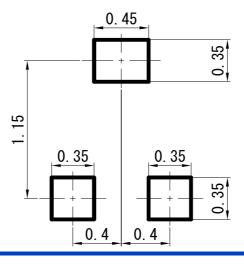
SSSMini3-F2-B

Transistors with Built-in Resistor DRC3144T0L

Unit: mm

1.20 ± 0.05 0.13-0.02 **0. 30**^{+0. 05} 0. 02 3 0.80±0.05 1.20 ± 0.05 20 2 1 **0. 20**+0. 05 -0. 02 0.20 ± 0.05 (0.4) (0.4) 0.80 ± 0.05 (5°) 27) 52 ± 0.03 ġ o' 0 to 0.05

Land Pattern (Reference) (Unit: mm)



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Established : 2009-10-27 Revised : 2014-03-20

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